

Product / Process Change Notification



N° 2017-126-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

Change of wafer production from Fraunhofer IMS (Duisburg) to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for C5SOI-wafers

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before **29. January 2021**.
- Infineon aligns with the widely-recognized JEDEC STANDARD "**JESD46**", which stipulates:
"Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG
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Chairman of the Supervisory Board: Dr. Wolfgang Eder
Management Board: Dr. Reinhard Ploss (CEO), Dr. Helmut Gassel, Jochen Hanebeck, Dr. Sven Schneider
Registered Office: Neubiberg
Commercial Register: München HRB 126492

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► **Products affected:**

Please refer to attached affected product list 1_cip17126_a

► **Detailed Change Information:**

Subject: Change of wafer production from Fraunhofer IMS (Duisburg) to Infineon Technologies (Kulim) Sdn. Bhd., Kulim, Malaysia for C5SOI-wafers.

Reason: The wafer production of the affected products will be transferred to location Infineon Technologies (Kulim) Sdn. Bhd., Malaysia, according to the global Infineon production strategy.

Description:

Old

New

wafer fab: Fraunhofer IMS

wafer fab: Infineon Kulim

wafer sort: Infineon Kulim

wafer sort: Infineon Kulim

► **Product Identification:**

Ensured by internal traceability in manufacturing execution systems.

► **Impact of Change:**

Based on the qualification performed, Infineon does not expect any negative impact on quality, function and reliability. No change in fit, form and function expected.

► **Attachments:**

Affected product list 1_cip17126_a

► **Time Schedule:**

- | | |
|-------------------------------|---|
| ■ Final qualification report: | 15-January-2021 |
| ■ First samples available: | 31-January-2021 |
| ■ Intended start of delivery: | Start of delivery of changed products beginning of April 2021, further delivery with unchanged products until stock is depleted |

If you have any questions, please do not hesitate to contact your local Sales office.

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Sales name	SP number	OPN	Package
IFCM10P60GD	SP001615606	IFCM10P60GDXKMA1	DIP 36x21D
IFCM10S60GD	SP001615598	IFCM10S60GDXKMA1	DIP 36x21D
IFCM10S60GS	SP005427187	IFCM10S60GSXKMA1	DIP 36x21D
IFCM15P60GD	SP001614382	IFCM15P60GDXKMA1	DIP 36x21D
IFCM15S60GD	SP001504638	IFCM15S60GDXKMA1	DIP 36x21D
IFCM15S60GS	SP001678818	IFCM15S60GSXKMA1	DIP 36x21D
IFCM15S60GS	SP005349915	IFCM15S60GSAKMA1	DIP 36x21D
IFCM20T65GD	SP001333972	IFCM20T65GDXKMA1	DIP 36x21D
IFCM20U65GD	SP001423502	IFCM20U65GDXKMA1	DIP 36x21D
IFCM30T65GD	SP001423504	IFCM30T65GDXKMA1	DIP 36x21D
IFCM30U65GD	SP001423506	IFCM30U65GDXKMA1	DIP 36x21D
IGCM04F60GA	SP001246994	IGCM04F60GAXKMA1	DIP 36x21
IGCM04G60GA	SP001370886	IGCM04G60GAXKMA1	DIP 36x21
IGCM04G60HA	SP001246998	IGCM04G60HAXKMA1	DIP 36x21
IGCM04G60HA	SP001246998	IGCM04G60HAXKMA1	DIP 36x21
IGCM06F60GA	SP001247004	IGCM06F60GAXKMA1	DIP 36x21
IGCM06F60GA	SP005408650	IGCM06F60GAAKMA1	DIP 36x21
IGCM06G60GA	SP001370894	IGCM06G60GAXKMA1	DIP 36x21
IGCM10F60GA	SP001247016	IGCM10F60GAXKMA1	DIP 36x21
IGCM10F60GA	SP005349925	IGCM10F60GAAKMA1	DIP 36x21
IGCM15F60GA	SP001247022	IGCM15F60GAXKMA1	DIP 36x21
IGCM15F60GA	SP005349927	IGCM15F60GAAKMA1	DIP 36x21
IGCM20F60GA	SP001247028	IGCM20F60GAXKMA1	DIP 36x21
IGCM20F60GA	SP005349929	IGCM20F60GAAKMA1	DIP 36x21
IKCM10H60GA	SP001247198	IKCM10H60GAXKMA1	DIP 36x21
IKCM10H60GA	SP005349937	IKCM10H60GAAKMA1	DIP 36x21
IKCM10L60GA	SP001370916	IKCM10L60GAXKMA1	DIP 36x21
IKCM15F60GA	SP001247202	IKCM15F60GAXKMA1	DIP 36x21
IKCM15F60GA	SP005349939	IKCM15F60GAAKMA1	DIP 36x21
IKCM15F60GA3	SP005422793	IKCM15F60GA3XKMA1	DIP 36x21
IKCM15H60GA	SP001247204	IKCM15H60GAXKMA2	DIP 36x21
IKCM15H60GA	SP001370906	IKCM15H60GAXKMA1	DIP 36x21
IKCM15H60GA	SP005401017	IKCM15H60GAAKMA2	DIP 36x21
IKCM15H60GA	SP005401019	IKCM15H60GAAKMA1	DIP 36x21
IKCM15L60GA	SP001247208	IKCM15L60GAXKMA1	DIP 36x21
IKCM15L60GA	SP005349941	IKCM15L60GAAKMA1	DIP 36x21
IKCM15L60GB	SP001678798	IKCM15L60GBXKMA1	DIP 36x21
IKCM15L60GD	SP001370928	IKCM15L60GDXKMA1	DIP 36x21D
IKCM15L60GD	SP005349931	IKCM15L60GDAKMA1	DIP 36x21D
IKCM15L60GD	SP005399351	IKCM15L60GDAKMA2	DIP 36x21D
IKCM15L60GS	SP005353350	IKCM15L60GSAKMA1	DIP 36x21D
IKCM15L60GS	SP005399267	IKCM15L60GSXKMA1	DIP 36x21D
IKCM15R60GD	SP001370934	IKCM15R60GDXKMA1	DIP 36x21D
IKCM20L60GA	SP001247214	IKCM20L60GAXKMA1	DIP 36x21
IKCM20L60GB	SP001723930	IKCM20L60GBXKMA1	DIP 36x21
IKCM20L60GD	SP001299274	IKCM20L60GDXKMA1	DIP 36x21D
IKCM20L60GD	SP005349933	IKCM20L60GDAKMA1	DIP 36x21D
IKCM20L60GD	SP005550554	IKCM20L60GDAKMA2	DIP 36x21D
IKCM20R60GD	SP001293434	IKCM20R60GDXKMA1	DIP 36x21D
IKCM30F60GA	SP001247216	IKCM30F60GAXKMA1	DIP 36x21
IKCM30F60GA	SP005401021	IKCM30F60GAAKMA1	DIP 36x21

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Sales name	SP number	OPN	Package
IKCM30F60GD	SP001271892	IKCM30F60GDXKMA1	DIP 36x21D
IKCM30F60GD	SP005349935	IKCM30F60GDAKMA1	DIP 36x21D
IKCM30F60GS	SP005353352	IKCM30F60GSAKMA1	DIP 36x21D
IKCM30F60GS	SP005399269	IKCM30F60GSXKMA1	DIP 36x21D
IM512-L6A	SP001723938	IM512L6AXKMA1	DIP 36x21
IM513-L6A	SP001723954	IM513L6AXKMA1	DIP 36x21
IM535-U6D	SP003944830	IM535U6DXKMA1	DIP 36x21D
IM535-U6DS	SP003965378	IM535U6DSXKMA1	DIP 36x21D
IM564-X6D	SP003014000	IM564X6DAKMA1	DIP 36x21D
IM564-X6D	SP005408854	IM564X6DXKMA1	DIP 36x21D
IM564-X6DS	SP003014004	IM564X6DSAKMA1	DIP 36x21D
IM564-X6DS	SP005408860	IM564X6DSXKMA1	DIP 36x21D